



A New Direction in Mixed-Signal

October 2012

XRP2997

2A DDR I/II/III Bus Termination Regulator

Rev. 1.2.0

GENERAL DESCRIPTION

The XRP2997 is a Double Data Rate (DDR) termination voltage regulator supporting all power requirements of DDR I, II and III memories and is capable of sinking or sourcing 2A continuously.

Tightly regulating its output voltage within $\pm 20\text{mV}$, the XRP2997 converts input voltages as low as 1.1V while the output voltage is adjustable through an external resistor divider or by forcing the V_{REF} pin voltage. It maintains a fast line and load transient response and only requires an output capacitance of $22\mu\text{F}$ to operate. An enable function via an external MOSFET and a soft start feature allow for a controlled implementation of power-up sequencing.

Built-in source/sink overcurrent, over-temperature and under-voltage lockout protections insure safe operation under abnormal operating conditions.

The XRP2997 meets JEDEC SSTL-2, SSTL-18, HSTL, SCSI-1 and SCSI-3 specifications for DDR SDRAM memories.

The XRP2997 is offered in a RoHS compliant, "green"/halogen free 8-pin Exposed Pad SOIC package.

APPLICATIONS

- **DDR I/II/III Memory Termination**
- **Active Termination Buses**
- **Audio-Video Equipments**
- **Video-Graphics Cards**

FEATURES

- **DDR1, DDR2 and DDR3 Support**
 - $0.75V_{\text{TT}}$ Generation
 - $\pm 20\text{mV}$ Output Voltage Offset
- **2 Amps Continuous Current Sourcing & Sinking**
 - 1.1V to 5.5V Wide Input Voltage Range
- **Adjustable Output Voltage**
- **Suspend to RAM(STR), Enable & Soft Start Functions**
- **Stable with $22\mu\text{F}$ Ceramic Capacitor**
- **UVLO, Over Temperature and Over Current Protections**
- **Minimal External Components**
- **Pin/Function Compatible with SP2996B**
- **RoHS Compliant "Green"/Halogen Free 8-Pin SOIC Package**

TYPICAL APPLICATION DIAGRAM

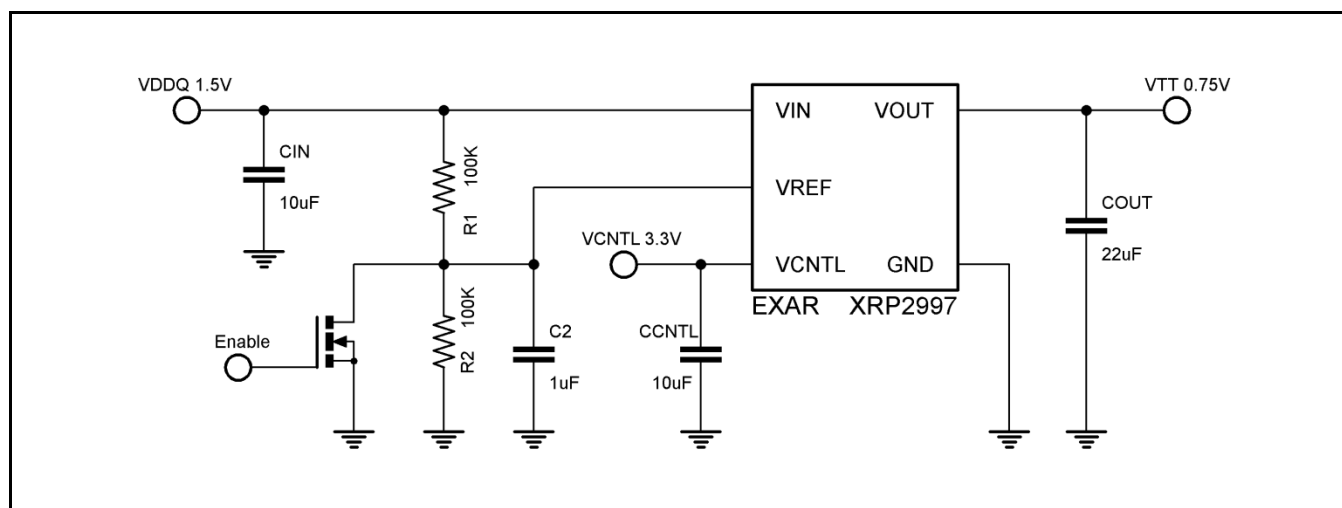


Fig. 1: XRP2997 DDRIII V_{TT} Application Diagram

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ABSOLUTE MAXIMUM RATINGS

These are stress ratings only and functional operation of the device at these ratings or any other above those indicated in the operation sections of the specifications below is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

V_{IN} , V_{REF} , V_{CNTL} -0.3V to 6.0V
 Junction Temperature Range.....-40°C to +150°C
 Storage Temperature-65°C to +150°C
 Lead Temperature (Soldering, 10 sec)..... 260°C

OPERATING RATINGS

Operating Temperature Range -40°C to +85°C
 Thermal Resistance θ_{JA} 60°C/W
 Thermal Resistance θ_{JC} 16°C/W

ELECTRICAL SPECIFICATIONS

Specifications are for an Operating Ambient Temperature of $T_A = 25^\circ\text{C}$ only; limits applying over the full Operating Junction Temperature range are denoted by a "•". Minimum and Maximum limits are guaranteed through test, design, or statistical correlation. Typical values represent the most likely parametric norm at $T_A = 25^\circ\text{C}$, and are provided for reference purposes only. Unless otherwise indicated, $V_{IN} = 1.8\text{V}/1.5\text{V}$, $V_{CNTL} = 3.3\text{V}$, $V_{REF} = 0.5 \times V_{IN}$, $C_{OUT} = 22\mu\text{F}$ (ceramic), $T_A = 25^\circ\text{C}$.

| Parameter | Min. | Typ. | Max. | Units | Conditions |
|--|-----------|---------|------|------------------|--|
| V_{IN} , Input Voltage Range | 1.1 | 1.8/1.5 | 5.5 | V | Keep $V_{CNTL} \geq V_{IN}$ during power on and power off sequences (note 4) |
| V_{CNTL} , Input Voltage Range | 2.375 | 3.3 | 5.5 | V | Keep $V_{CNTL} \geq V_{IN}$ during power on and power off sequences (note 4) |
| V_{OUT} , Output Voltage | V_{REF} | | | V | $I_{OUT} = 0\text{mA}$ |
| V_{OS} , Output Voltage Offset | -20 | | +20 | mV | $I_{OUT} = 0\text{mA}$ (note 1) |
| ΔV_{LOR} , Load Regulation | -20 | | +20 | mV | $I_{OUT} = 0.1\text{mA}$ to +2A |
| | -20 | | +20 | mV | $I_{OUT} = 0.1\text{mA}$ to -2A |
| I_Q , Quiescent Current | | 2 | 90 | μA | $V_{REF} < 0.2\text{V}$, $V_{OUT} = \text{OFF}$ |
| I_{CNTL} , Operating Current of V_{CNTL} | | 1 | 2.5 | mA | $I_{OUT} = 0\text{mA}$ |
| I_{REF} , Bias Current of V_{REF} | 0 | | 1 | μA | $V_{REF} = 1.25\text{V}$ |
| I_{IL} , Current Limit | 2.4 | 3 | | A | Source: $V_{OUT} = 0.33 \times V_{REF}$ Sink: $V_{OUT} = 0.95 \times V_{IN}$ (note 3) |
| R_{DSCHG} , Output Discharge Resistance | | 18 | 25 | Ω | $V_{REF} = 0\text{V}$, $V_{OUT} = 0.3\text{V}$ |
| Thermal Protection | | | | | |
| T_{SD} , Thermal Shutdown Temperature | | 160 | | $^\circ\text{C}$ | $3.3\text{V} \leq V_{CNTL} \leq 5\text{V}$, guaranteed by design (note 4) |
| Thermal Shutdown Hysteresis | | 30 | | $^\circ\text{C}$ | Guaranteed by design |
| Shutdown Specifications | | | | | |
| $V_{TRIGGER}$, Shutdown Threshold | 0.6 | | | V | Output ON $V_{REF} = 0\text{V} \rightarrow 1.25\text{V}$ |
| | | | 0.2 | | Output OFF $V_{REF} = 1.25\text{V} \rightarrow 0\text{V}$ |

Note 1: V_{OS} offset is the voltage measurement defined as V_{OUT} subtracted from V_{REF} .

Note 2: Load regulation is measured at constant junction temperature, using pulse testing with a short ON time.

Note 3: Current limit is measured by applying a short duration current pulse.

Note 4: In order to safely operate your system, V_{CNTL} must be $> V_{IN}$.

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BLOCK DIAGRAM

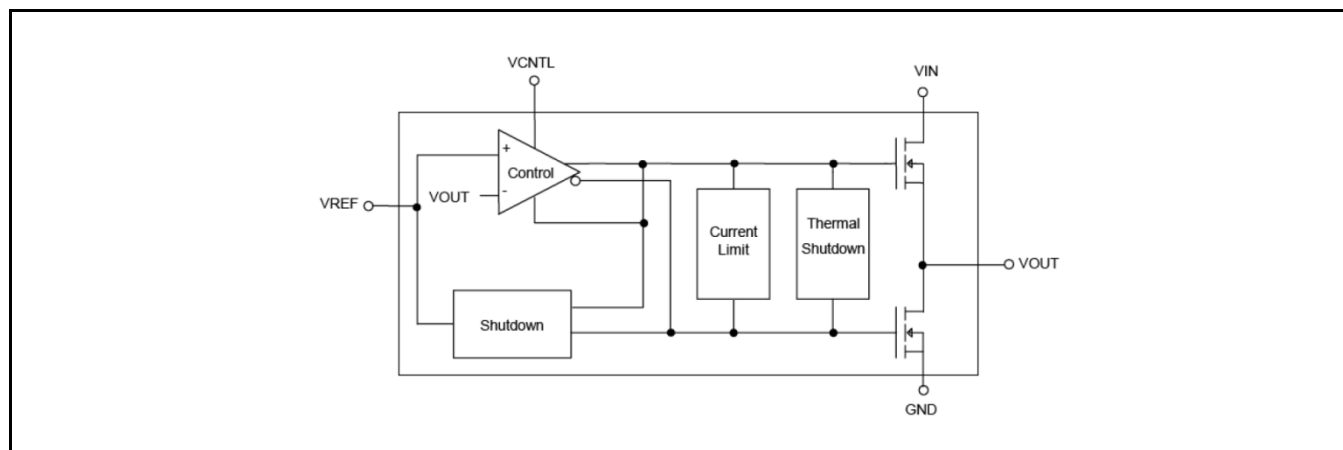


Fig. 2: XRP2997 Block Diagram

PIN ASSIGNMENT

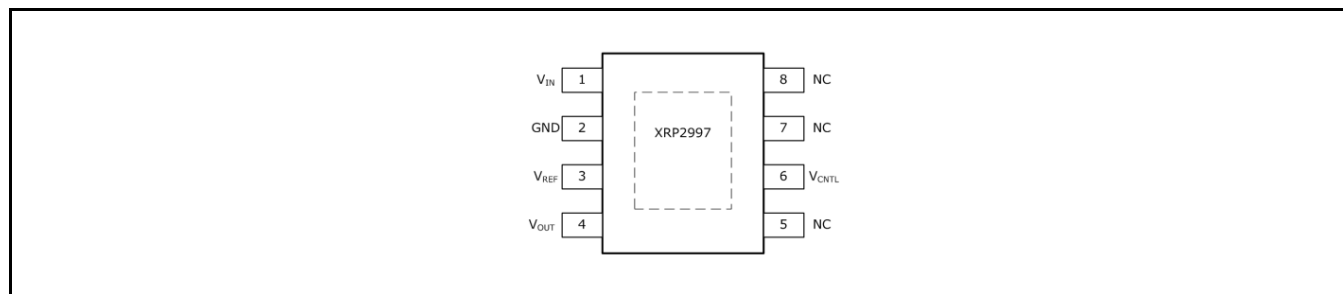


Fig. 3: XRP2997 Pin Assignment

PIN DESCRIPTION

| Name | Pin Number | Description |
|-------------------|-------------|---|
| V _{IN} | 1 | Power Input Voltage |
| GND | 2 | Ground Signal |
| | Exposed Pad | |
| V _{REF} | 3 | Reference Input Voltage. This input can also be used as an enable signal; pulling this pin low shuts down the XRP2997. Refer to typical application circuit. |
| V _{OUT} | 4 | Output Voltage |
| NC | 5, 7, 8 | NC |
| V _{CTRL} | 6 | Voltage for the driver circuit and all analog blocks |

ORDERING INFORMATION

| Part Number | Temperature Range | Marking | Package | Packing Quantity | Note 1 | Note 2 |
|----------------|--------------------------------|-----------------------------|-----------------------|------------------|--------------------------------|--------|
| XRP2997IDBTR-F | -40°C ≤ T _A ≤ +85°C | XRP2997I YYWWF XXXXXX | Exposed pad SOIC-8 | 2.5K/Tape & Reel | RoHS Compliant Halogen Free | |

“YY” = Year – “WW” = Work Week – “L” = Lead Free Indicator – “X” = Lot Number; when applicable.

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TYPICAL PERFORMANCE CHARACTERISTICS

All data taken at $V_{IN} = 1.8V/1.5V$, $V_{CNTL} = 3.3V$, $V_{REF} = 0.5 \times V_{IN}$, $C_{OUT} = 22\mu F$ (ceramic), $T_A = 25^\circ C$, unless otherwise specified
- Schematic and BOM from Application Information section of this datasheet.

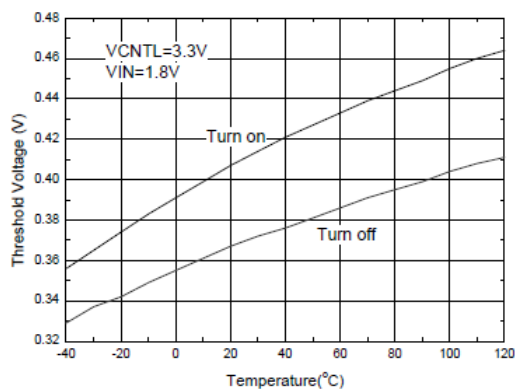


Fig. 4: Turn on and turn off vs. Temperature

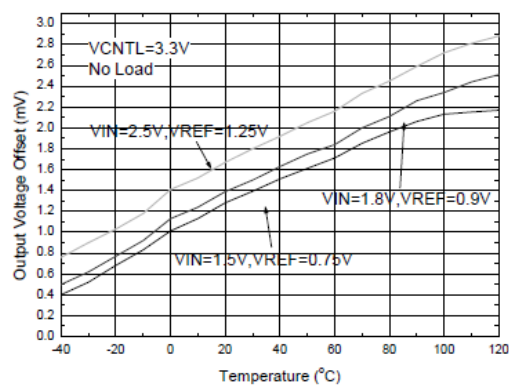


Fig. 5: Output Voltage vs. Temperature

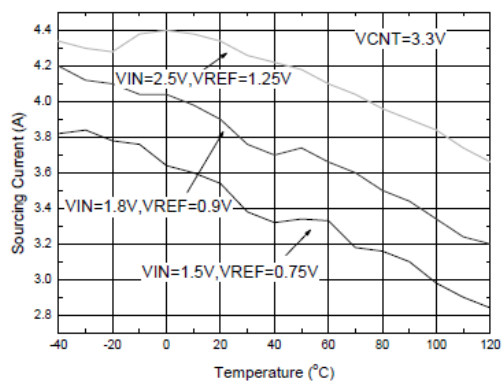


Fig. 6: Current limit (sourcing) vs. Temperature

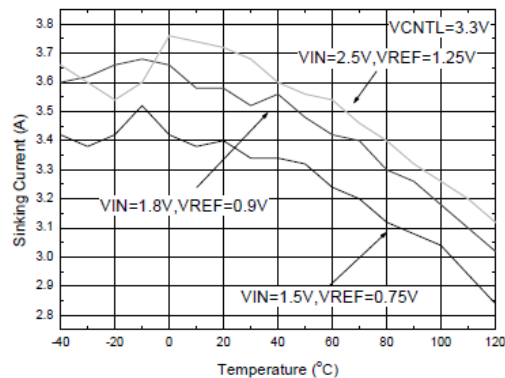


Fig. 7: Current limit (sinking) vs. Temperature

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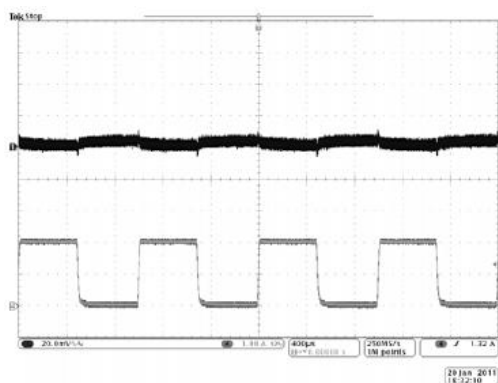


Fig. 8: $V_{IN}=1.5V$, $V_{REF}=0.75V$ source response

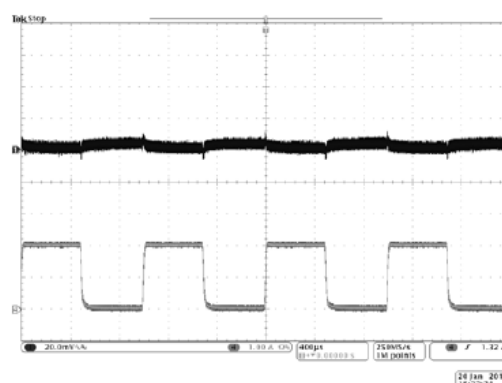


Fig. 9: $V_{IN}=1.8V$, $V_{REF}=0.9V$ source response

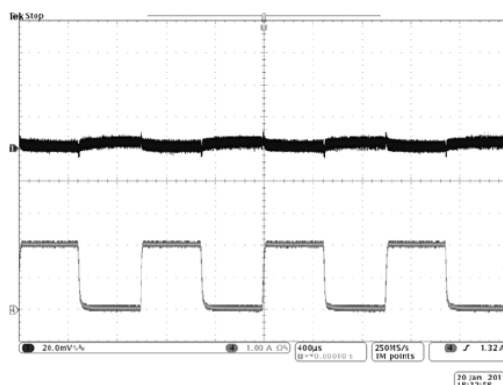


Fig. 10: $V_{IN}=2.5V$, $V_{REF}=1.25V$ source response

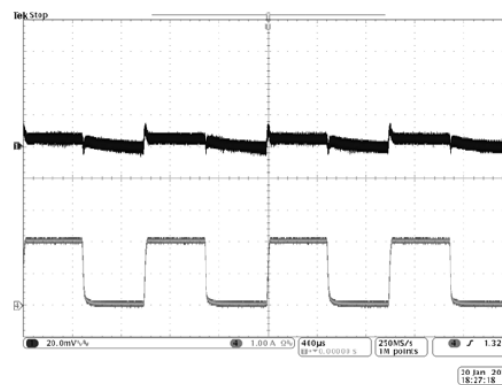


Fig. 11: $V_{IN}=1.5V$, $V_{REF}=0.75V$ sink response

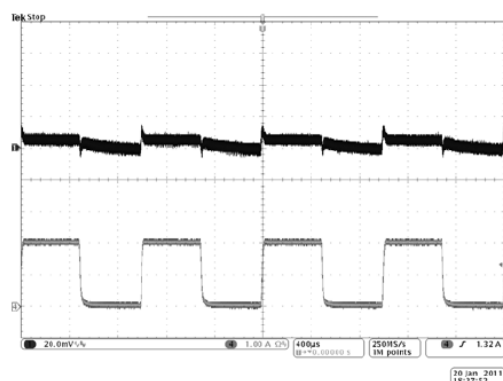


Fig. 9: $V_{IN}=1.8V$, $V_{REF}=0.9V$ sink response

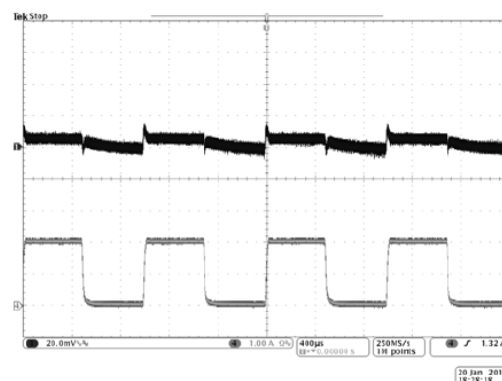


Fig. 10: $V_{IN}=2.5V$, $V_{REF}=1.25V$ sink response

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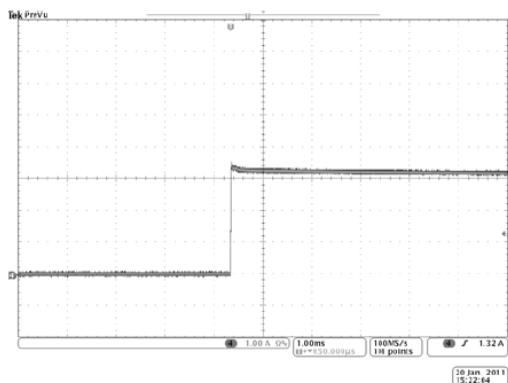


Fig. 14: $V_{IN}=1.5V$, $V_{REF}=0.75V$ source short circuit

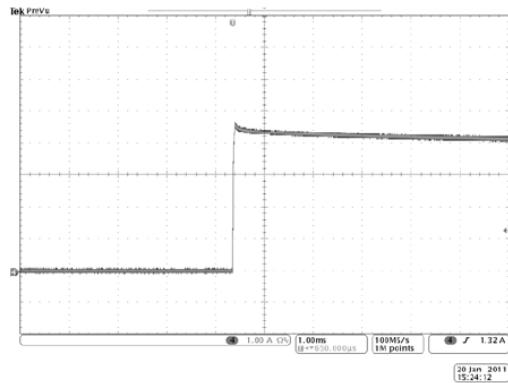


Fig. 15: $V_{IN}=1.8V$, $V_{REF}=0.9V$ source short circuit

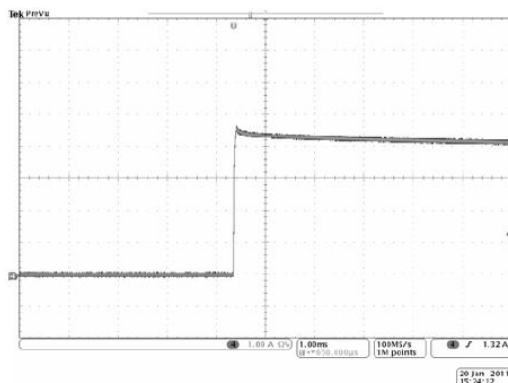


Fig. 11: $V_{IN}=2.5V$, $V_{REF}=1.25V$ source short circuit

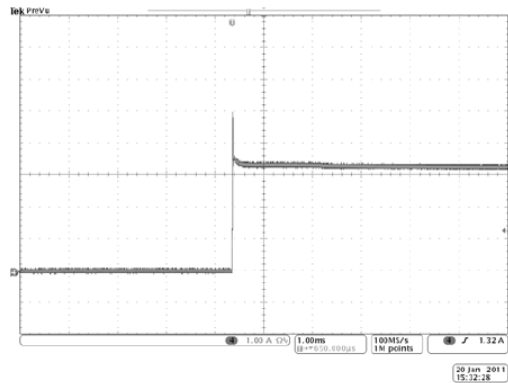


Fig. 12: $V_{IN}=1.5V$, $V_{REF}=0.75V$ sink short circuit

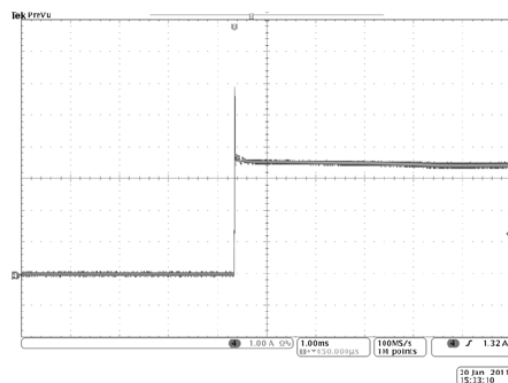


Fig. 13: $V_{IN}=1.8V$, $V_{REF}=0.9V$ sink short circuit

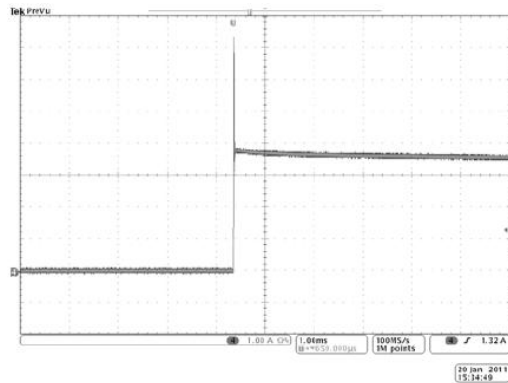


Fig. 14: $V_{IN}=2.5V$, $V_{REF}=1.25V$ sink short circuit

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APPLICATION INFORMATION

INPUT CAPACITOR C_{IN}

Select the input capacitor C_{IN} for voltage rating, RMS current rating and capacitance. The voltage rating should be at least 50% higher than the regulator's maximum input voltage. The value of this capacitor, its charge, should be selected in order to be able to supply enough current to the XRP2997 in the event of a transient increase of source current required. A minimum value of 10μF is advised while a recommended value of 47μF is

recommended for optimum transient response performance.

LAYOUT CONSIDERATIONS

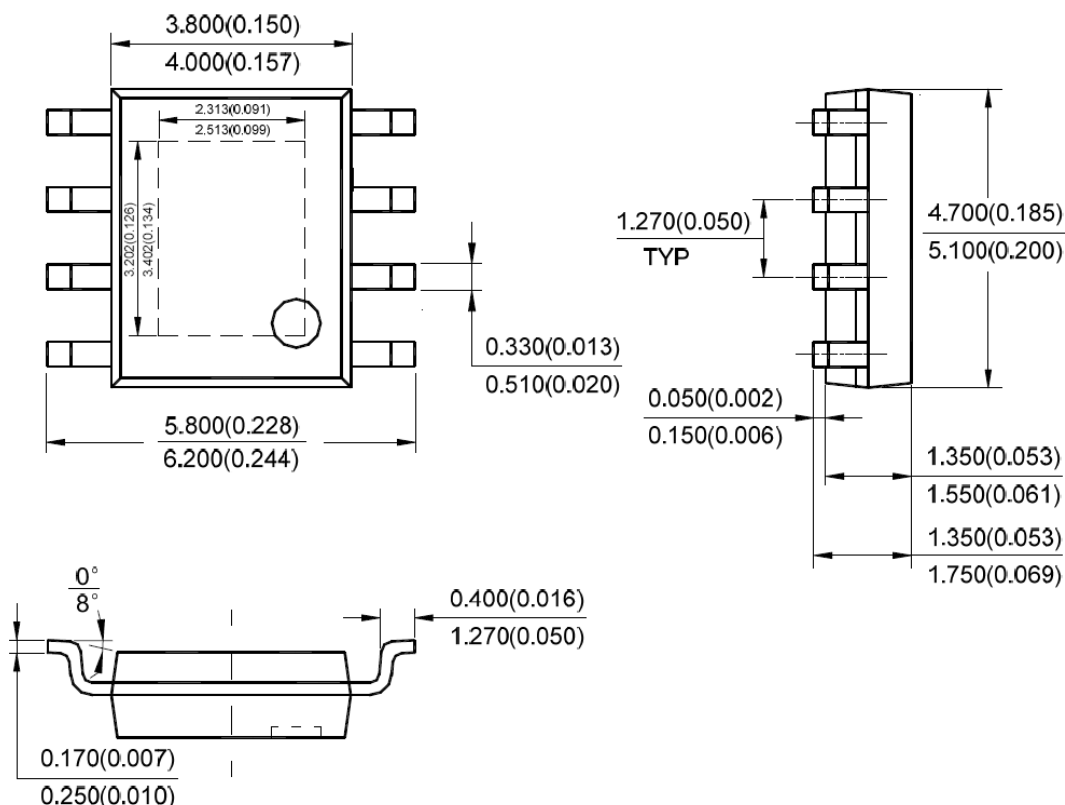
The XRP2997 is offered in the 8-pin exposed-pad SOIC package in order to facilitate power dissipation (heat dissipation). Power dissipation can be maximized by soldering the exposed pad to a large land area on top layer of PCB and by using vias to connect the exposed pad to an interlayer(s) or bottom layer. All capacitors should be placed as close as possible to the respective pins.

PACKAGE SPECIFICATION

8-PIN SOIC EXPOSED PAD

Unit: mm (inch)

Eject hole, oriented hole and mold mark are optional.



2A DDR I/II/III Bus Termination Regulator**REVISION HISTORY**

| Revision | Date | Description |
|----------|------------|---|
| 1.0.0 | 07/22/2011 | Initial release of datasheet |
| 1.1.0 | 01/09/2012 | Corrected part number in ordering information |
| 1.1.1 | 03/29/2012 | Corrected turn on threshold from 0.8V to 0.6V. Typographical error. |
| 1.2.0 | 10/29/2012 | Reformat of datasheet Updated typical application schematics (figure 1) Addition of CIN selection under Application Information section |

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